

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT2963948

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SATORU ARAKI	07/24/2014
DIANE L. BROWN	07/24/2014
HIROAKI CHIHAYA	07/24/2014
DUSTIN W. ERICKSON	07/24/2014
DAVID J. SEAGLE	07/29/2014
RECEIVING PARTY DATA	
Name:	HGST NETHERLANDS B.V.
Street Address:	HERIKERBERGWEG 238
Internal Address:	LUNA ARENA
City:	AMSTERDAM
State/Country:	NETHERLANDS
Postal Code:	1101 CM
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14449119
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	HSJ920100015US3
NAME OF SUBMITTER:	STEVEN H. VERSTEEG
SIGNATURE:	/Steven H. VerSteeg/
DATE SIGNED:	08/01/2014

Total Attachments: 4

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ASSIGNMENT FOR PATENT APPLICATION


Whereas, We the undersigned inventors have invented certain improvements as set forth in the patent application entitled:

MATERIAL FOR USE IN A TMR READ GAP WITHOUT ADVERSELY AFFECTING THE TMR EFFECT

Whereas, HGST Netherlands B.V., having a place of business at Herikerbergweg 238, Luna Arena, 1101 CM Amsterdam, Netherlands (hereinafter referred to as "HGST"), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to HGST, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HGST, its successors and assigns; and we hereby agree that HGST may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by HGST.

Signed on the dates indicated beside our signatures.

- 1) Signature:  Date: 7/24/2014
 Typed Name: Toru ARAKI
- 2) Signature: _____ Date: _____
 Typed Name: Diane L. BROWN
- 3) Signature: _____ Date: _____
 Typed Name: Hiroaki CHIHAYA
- 4) Signature: _____ Date: _____
 Typed Name: Dustin W. ERICKSON
- 5) Signature: _____ Date: _____
 Typed Name: David J. SEAGLE

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- 1) Signature: _____ Date: _____
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- 1) Signature: _____ Date: _____
Typed Name: Satoru ARAKI

- 2) Signature: _____ Date: _____
Typed Name: Diane L. BROWN

- 3) Signature: Hiroaki Chihaya Date: July 29th 2018
Typed Name: Hiroaki CHIHAYA

- 4) Signature: _____ Date: _____
Typed Name: Dustin W. ERICKSON

- 5) Signature: _____ Date: _____
Typed Name: David J. SEAGLE

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